## NSN 3439-01-459-2000

Soldering Flux - Page 1 of 1



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Environmental Protection:
Corrosion resistant
Physical Form:
Liquid
Material For Which Formulated:
Copper and tin
Content Within Each Unit Package:
1 gal
Special Features:
186 rosin flux; flux is moisture and fungus resistant; designed for wave/drag soldering of single sided/double sided/multi-layer circuit board
assemblies; used for soldering multi-layer assemblies which require a high preheat temperature; used in foam fluxing equipment; specific
gravity at 75 deg. F; flash point 65 deg. F; solder spread factor 95 mm
Shelf Life:
N/a
Unit Of Measure:
-
Demilitarization:
No
Fiig:
T166-s